Special Issue

Intelligent Big Data Analysis for High-Dimensional Internet of Things

Message from the Guest Editors

Intelligent Big Data Analysis for High-Dimensional Internet of Things (IoT) is a complex and critical area of research that demands interdisciplinary expertise in data science, machine learning, and IoT. This Special Issue will supplement the existing literature by providing a platform for the latest research and advancements in intelligent big data analysis for high-dimensional IoT. It will also provide insights into the challenges and opportunities of this area of research and suggest future research directions.

The scope of this Special Issue is broad and encompasses various domains related to IoT, such as smart cities, healthcare, transportation, and industrial automation. It includes topics such as big data analytics, machine learning, data mining, natural language processing, and deep learning. The Special Issue will be a valuable resource for researchers, practitioners, and industry experts working in the field of IoT and data analytics.

Guest Editors

Dr. Wanfu Gao

Dr. Yuzhou Liu

Dr. Ping Zhang

Deadline for manuscript submissions

closed (15 September 2024)

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Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guestedited by leading experts in selected topics of interest.

Editor-in-Chief

Prof. Dr. Flavio Canavero
Department of Electronics and Telecommunications, Politecnico di Torino, 10129 Torino, Italy

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